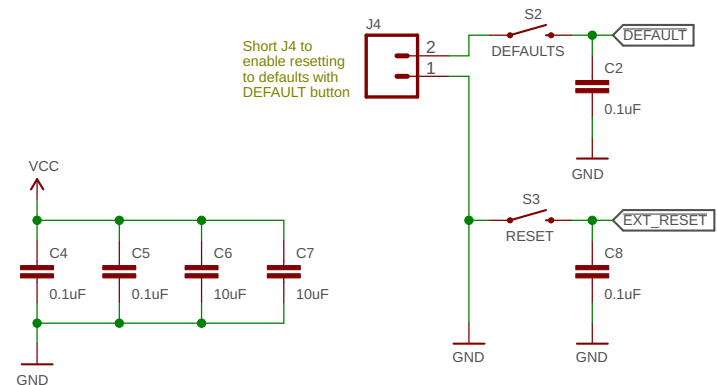
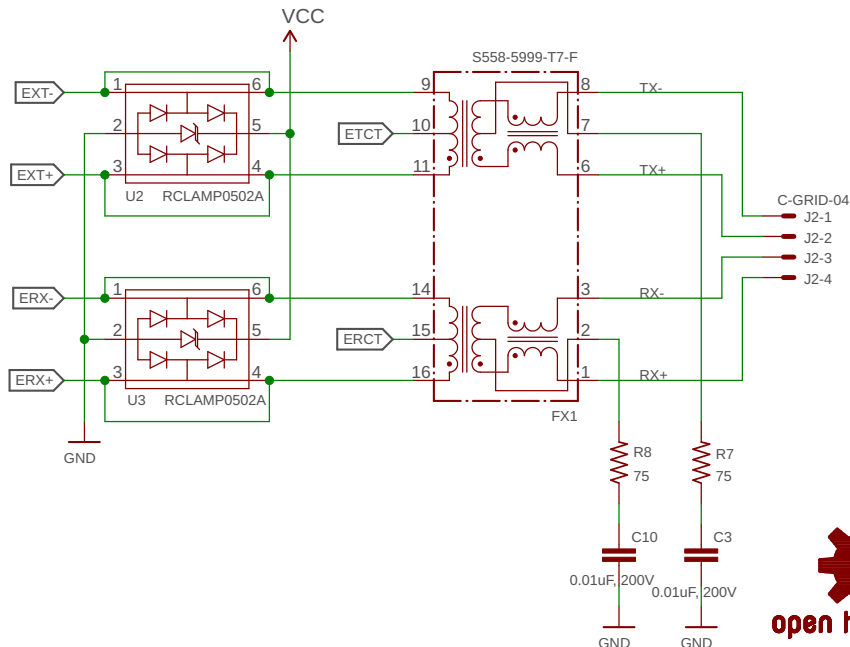
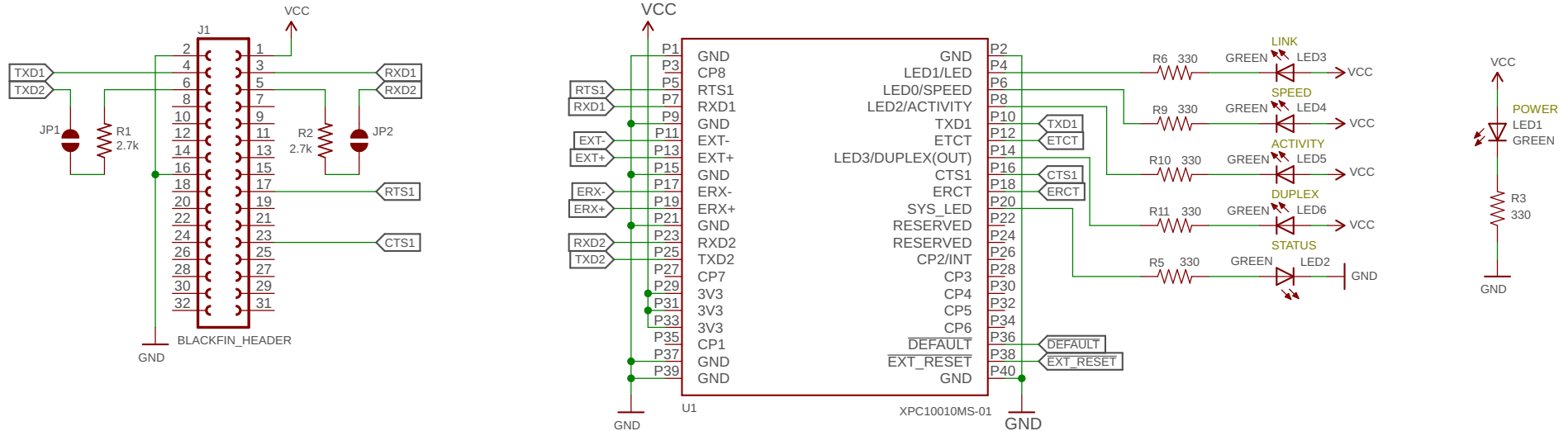


RCM-Comm Board v3.0_E (Ethernet)

Copyright 2019 Engineering^3 LLC Copyright and related rights are licensed under the Solderpad Hardware License, Version 0.51 (the "License"); you may not use this file except in compliance with the License. You may obtain a copy of the License at <http://solderpad.org/licenses/SHL-0.51>. Unless required by applicable law or agreed to in writing, software, hardware and materials distributed under this License is distributed on an "AS IS" BASIS, WITHOUT WARRANTIES OR CONDITIONS OF ANY KIND, either express or implied. See the License for the specific language governing permissions and limitations under the License.

05/30/16 BPS Removed big holes with copper ring, added same dia but normal holes, moved them so they sit better on other boards in the stack.



Designed for Tim Jump of Engineering^3
by Brian Schmalz of Schmalz Haus LLC
Copyright 2019 Engineering^3 LLC

TITLE: RCM-Comm_v3_E

Document Number:

REV:

Date: 3/16/2019 4:52 PM

Sheet: 1/1



RoHS Garbage